



Product Change Notification

Change Notification #: 115131 - 01
Change Title: Intel® Server Board S2600TPFR,
PCN 115131-01,
Product Design, Product Material,
Replacement of components listed under
RoHS exemption 7c-I, Updated
BIOS/ME/BMC/FRUSDR Firmware, Add a
pull-up resistor on motherboards,
**Reason for Revision: Correct spelling of
product name (S2600TPFR)**
Date of Publication: November 30, 2016

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Dec 14, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Reason for Revision: Correct spelling of product name (S2600TPFR)

Intel is implementing the following changes on the Intel® Server Board [S2600TPFR](#)

1. Intel is replacing components containing substances listed under EU RoHS exemption 7c-I with exemption-free components. All new components are identical in form factor and function to the replaced ones.
2. Intel is implementing the System Firmware installed at the Factory:
 - a. Update the BIOS from revision R01.01.0014 to revision R01.01.0016.
 - b. Update the Management Engine (ME) firmware from revision 03.01.03.005 to revision 03.01.03.021.
 - c. Update the Integrated Baseboard Management Controller (BMC) firmware from revision 1.39.9375 to revision 01.43.9685.
 - d. Update the FRUSDR from revision 1.13 to revision 1.14

The system software update package, including the release notes for each, is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

3. Intel is implementing the following changes on the Intel® Server Board [S2600TPFR](#):

Place a 200.00k ohms, 1.00%, 1/16W resistor on motherboard in location R4N25 to prevent USB over current events in Linux logs when building the systems without any of Intel® Bridge Board FHWKPTPBGB, AHWKPTP12GBGB or AHWKPTP12GBGBR5.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customers perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
BBS2600TPFR	943947	H48902-013	H14263-261	H48902-014	H14263-271

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
November 29, 2016	00	Originally Published PCN
November 30, 2016	01	Correct spelling of product name (S2600TPFR)



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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